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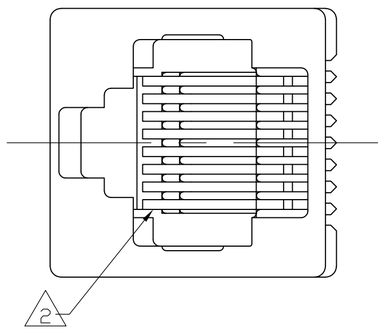
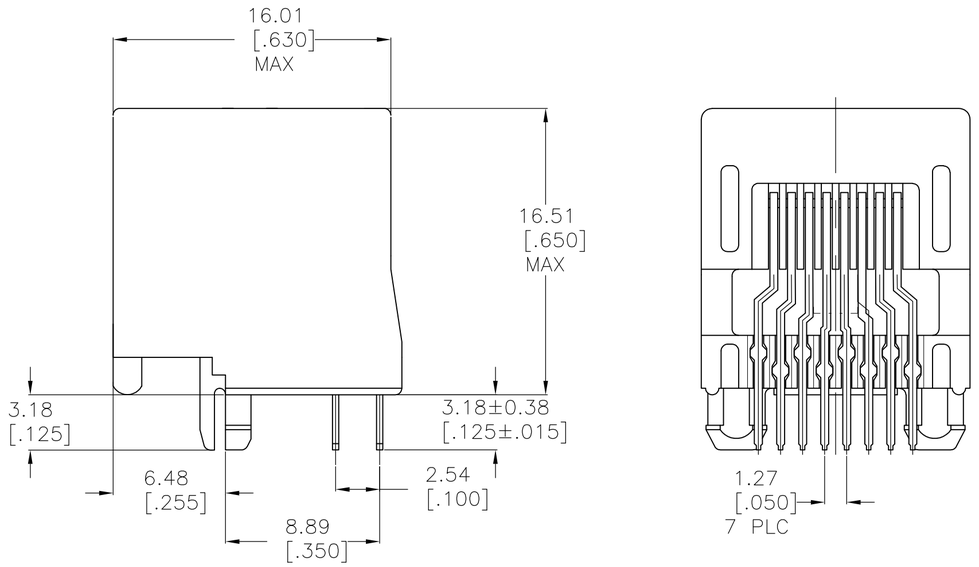
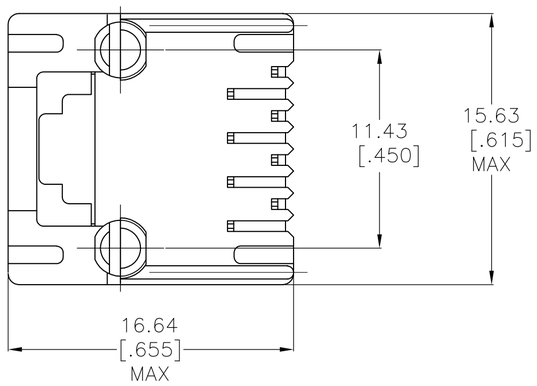
LOC	DIST
AA	00

REVISIONS

P	LTR	DESCRIPTION	DATE	DWN	APVD
	B	ECO-07-017784	14AUG07	LAM	PR



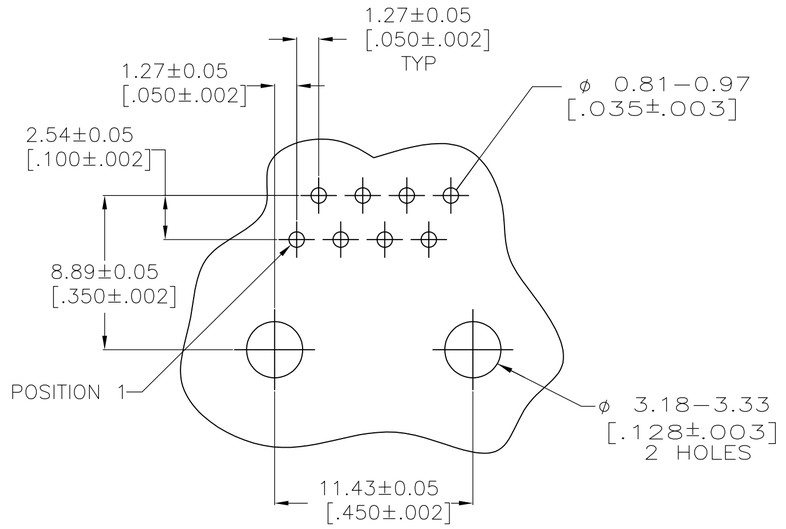




1. MATERIAL: HOUSING – HTN MOLDING COMPOUND, UL 94V-0 COLOR: BLACK
TERMINAL – 0.36[.014] THICK PHOS BRONZE PLATED WITH 1.27µm [.000050] MIN THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA, 3.81µm [.000150] MIN THICK MATTE TIN IN SOLDER AREA AND 1.27µm [.000050] MIN THICK NICKEL UNDERPLATE

2. CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68 AND REA BULLETIN 345-81 PE-76 SPECIFICATION FOR MODULAR TELEPHONE HARDWARE.

3. BULK PACKAGED IN A TRAY.



SUGGESTED PRINTED CIRCUIT BOARD LAYOUT

COMPONENT SIDE

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: mm [INCHES]

TOLERANCES UNLESS OTHERWISE SPECIFIED:

0 PLC	± –
1 PLC	± –
2 PLC	± 0.13[.005]
3 PLC	± –
4 PLC	± –
ANGLES	± –

MATERIAL: SEE NOTE 1

FINISH: SEE NOTE 1

DWN	L.A.MAYER 06JUN2005
CHK	P.RECCE 14AUG2007
APVD	S. FLICKINGER 14AUG2007
PRODUCT SPEC	108-1163
APPLICATION SPEC	114-2048
WEIGHT	–

Tyco Electronics Corporation
Harrisburg, PA 17105-3608

NAME: MODULAR JACK ASSEMBLY, TOP ENTRY, 8 POSITION, FLANGELESS

SIZE	CAGE CODE	DRAWING NO	RESTRICTED TO
A2	00779	C-5569284	–

CUSTOMER DRAWING | SCALE 4:1 | SHEET 1 OF 1 | REV B

5569284